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Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications. (Note 9)

| Pulse Voltage from V $^+$ to V $^-$ (50 ms) | 50V |
|--|-------|
| Continuous Voltage from V ⁺ to V ⁻ | 40V |
| Input-Output Voltage Differential | 40V |
| Maximum Amplifier Input Voltage (Either Input) | 8.5V |
| Maximum Amplifier Input Voltage (Differential) | 5V |
| Current from VZ | 25 mA |
| Current from V _{REF} | 15 mA |

| Internal Power Dissipation Metal Can (Note 1) | 800 mW | | |
|---|-------------------|--|--|
| Cavity DIP (Note 1) | 900 mW | | |
| Molded DIP (Note 1) | 660 mW | | |
| Operating Temperature Range LM723 -55°C to LM723C 0°C to | +150°C x +70°C | | |
| Storage Temperature Range Metal Can -65° C to Molded DIP -55° C to | | | |
| Lead Temperature (Soldering, 4 sec. max.) | | | |
| Hermetic Package | 300°C | | |
| Plastic Package | 260°C | | |
| ESD Tolerance | 1200V | | |
| (Human body model, 1.5 k Ω in series with 100 pl | F) | | |

Electrical Characteristics (Notes 2, 9)

| Parameter | Conditions | | LM723 | | | LM723 | | |
|---|--|------|-----------|--------------------|------|-----------|-------------------|--|
| | | Min | Тур | Max | Min | Тур | Max | Units |
| Line Regulation | $V_{IN} = 12V \text{ to } V_{IN} = 15V \\ -55^{\circ}\text{C} \le T_{A} \le +125^{\circ}\text{C} \\ 0^{\circ}\text{C} \le T_{A} \le +70^{\circ}\text{C} \\ V_{A} = 10^{14} \text{ to } V_{A} $ | | 0.01 | 0.1 0.3 | | 0.01 | 0.1 | % V _{OUT} % V _{OUT} % V _{OUT} |
| Load Regulation | $\begin{split} &V_{IN} = 12V \text{ to } V_{IN} = 40V \\ &I_L = 1 \text{ mA to } I_L = 50 \text{ mA} \\ &-55^\circ\text{C} \leq T_A \leq +125^\circ\text{C} \\ &0^\circ\text{C} \leq T_A \leq +70^\circ\text{C} \end{split}$ | | 0.02 | 0.2 0.15 0.6 | | 0.1 | 0.5 0.2 0.6 | % V _{OUT} % Vout % Vout % Vout |
| Ripple Rejection | f = 50 Hz to 10 kHz, $C_{REF} = 0$ f = 50 Hz to 10 kHz, $C_{REF} = 5 \mu F$ | | 74 86 | | | 74 86 | | dB dB |
| Average Temperature Coeffic- ient of Output Voltage (Note 8) | $\begin{array}{l} -55^\circ C \leq T_A \leq \ +125^\circ C \\ 0^\circ C \leq T_A \leq \ +70^\circ C \end{array}$ | | 0.002 | 0.015 | | 0.003 | 0.015 | %/°C %/°C |
| Short Circuit Current Limit | $R_{SC} = 10\Omega, V_{OUT} = 0$ | | 65 | | | 65 | | mA |
| Reference Voltage | | 6.95 | 7.15 | 7.35 | 6.80 | 7.15 | 7.50 | V |
| Output Noise Voltage | $\begin{array}{l} BW=100~Hz~to~10~kHz,C_{REF}=0\\ BW=100~Hz~to~10~kHz,C_{REF}=5~\muF \end{array}$ | | 86 2.5 | | | 86 2.5 | | μVrms μVrms |
| Long Term Stability | | | 0.05 | | | 0.05 | | %/1000 hrs |
| Standby Current Drain | $I_{L} = 0, V_{IN} = 30V$ | | 1.7 | 3.5 | | 1.7 | 4.0 | mA |
| Input Voltage Range | | 9.5 | | 40 | 9.5 | | 40 | V |
| Output Voltage Range | | 2.0 | | 37 | 2.0 | | 37 | V |
| Input-Output Voltage Differential | | 3.0 | | 38 | 3.0 | | 38 | V |
| $	heta_{JA}$ | Molded DIP | | | | | 105 | | °C/W |
| $	heta_{JA}$ | Cavity DIP | | 150 | | | | | °C/W |
| $	heta_{JA}$ | H10C Board Mount in Still Air | | 165 | | | 165 | | °C/W |
| $	heta_{JA}$ | H10C Board Mount in 400 LF/Min Air Flow | | 66 | | | 66 | | °C/W |
| $\theta_{\rm JC}$ | | | 22 | | | 22 | | °C/W |

Note 1: See derating curves for maximum power rating above 25°C.

Note 2: Unless otherwise specified, $T_A = 25^{\circ}$ C, $V_{IN} = V^+ = V_C = 12V$, $V^- = 0$, $V_{OUT} = 5V$, $I_L = 1$ mA, $R_{SC} = 0$, $C_1 = 100$ pF, $C_{REF} = 0$ and divider impedance as seen by error amplifier $\leq 10 \text{ k}\Omega$ connected as shown in *Figure 1*. Line and load regulation specifications are given for the condition of constant chip temperature. Temperature drifts must be taken into account separately for high dissipation conditions.

Note 3: L1 is 40 turns of No. 20 enameled copper wire wound on Ferroxcube P36/22-3B7 pot core or equivalent with 0.009 in. air gap.

Note 4: Figures in parentheses may be used if R1/R2 divider is placed on opposite input of error amp.

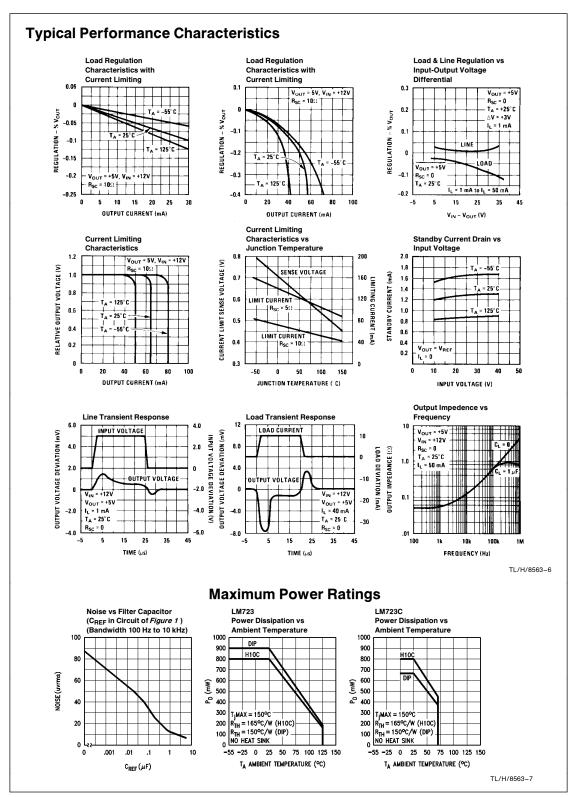
Note 5: Replace R1/R2 in figures with divider shown in Figure 13.

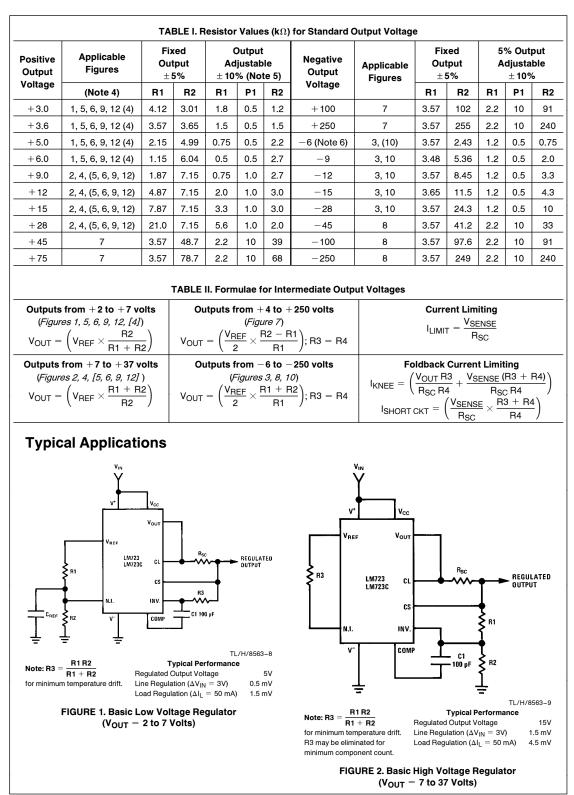
Note 6: V $^+$ and V $_{CC}$ must be connected to a $\,+\,3V$ or greater supply.

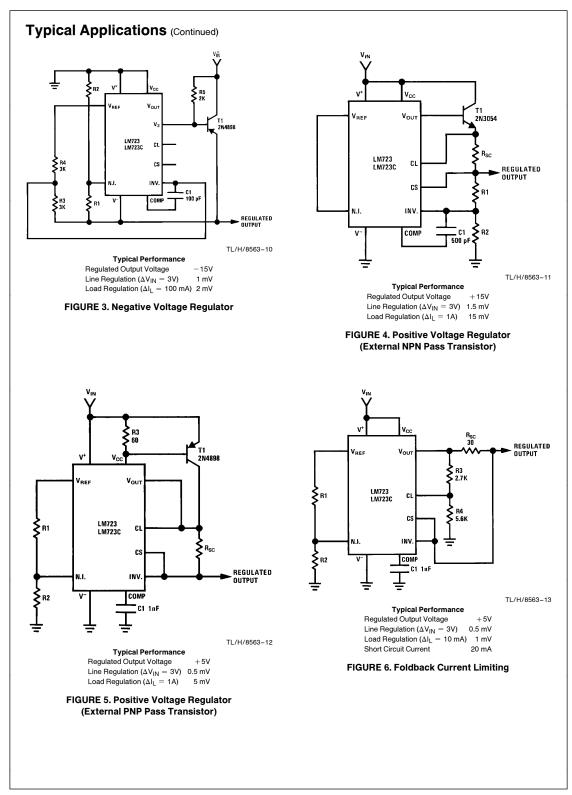
Note 7: For metal can applications where Vz is required, an external 6.2V zener diode should be connected in series with Vour.

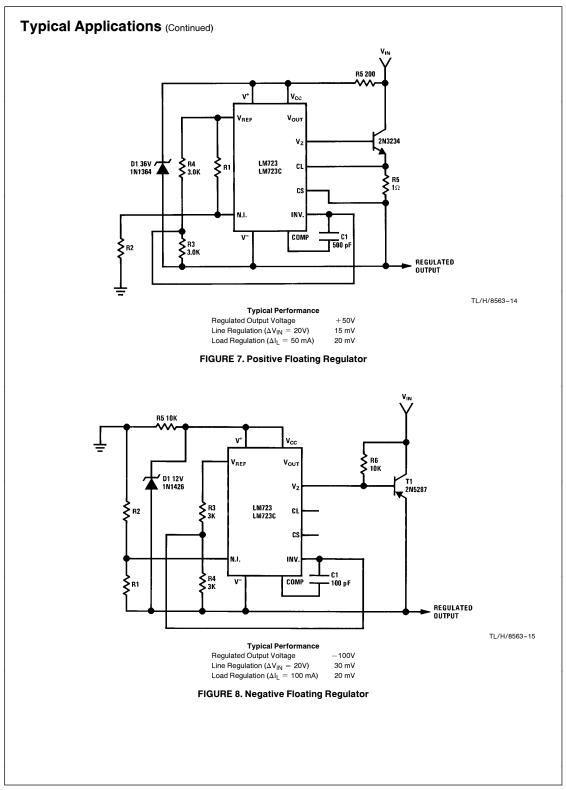
Note 8: Guaranteed by correlation to other tests.

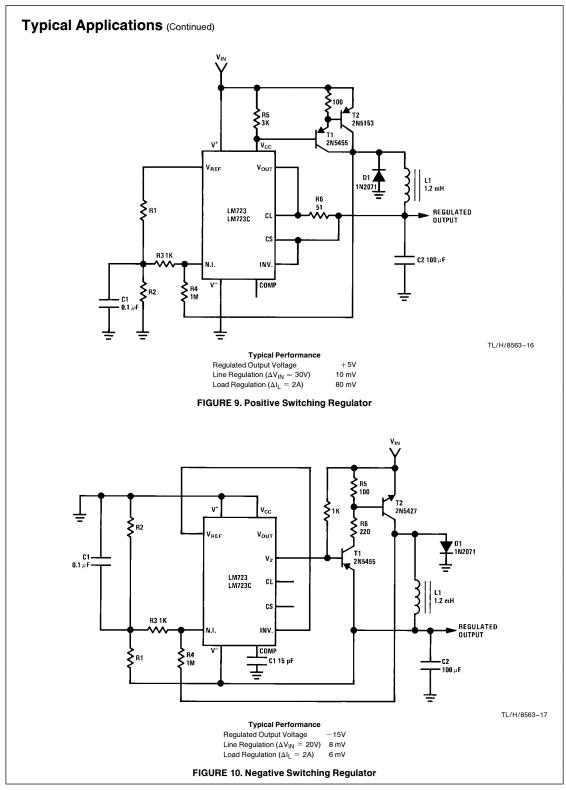
Note 9: A military RETS specification is available on request. At the time of printing, the LM723 RETS specification complied with the Min and Max limits in this table. The LM723E, H, and J may also be procured as a Standard Military Drawing.



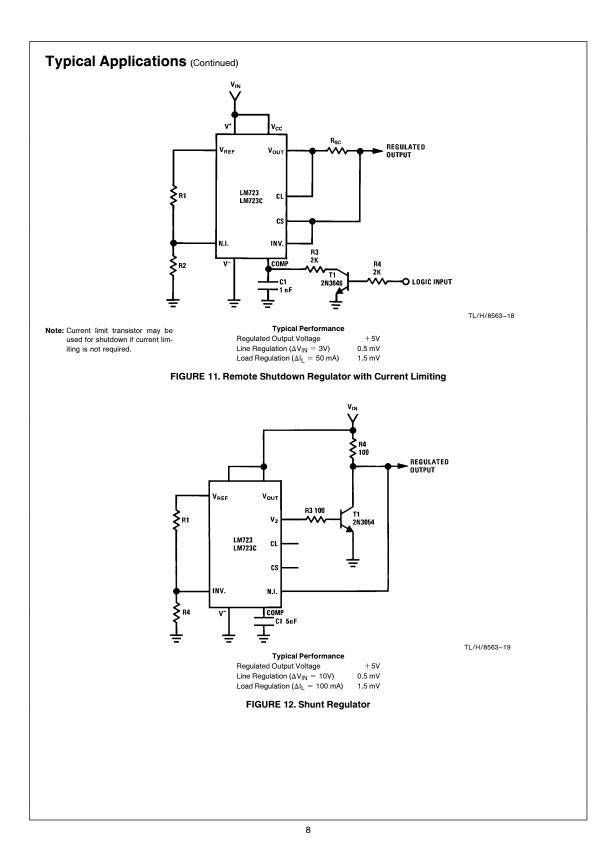


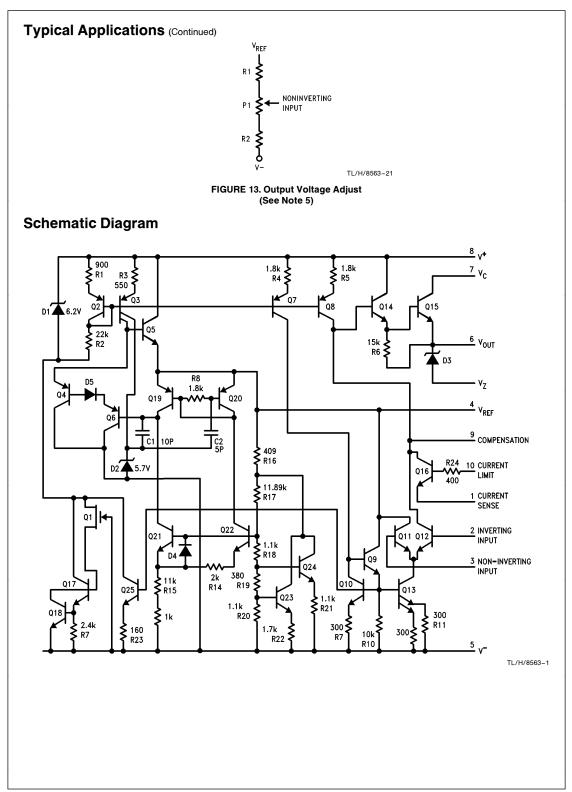


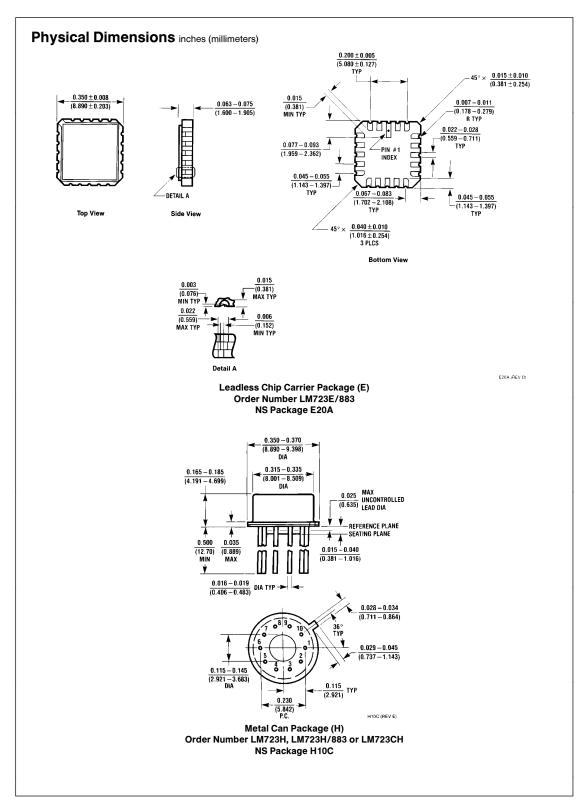


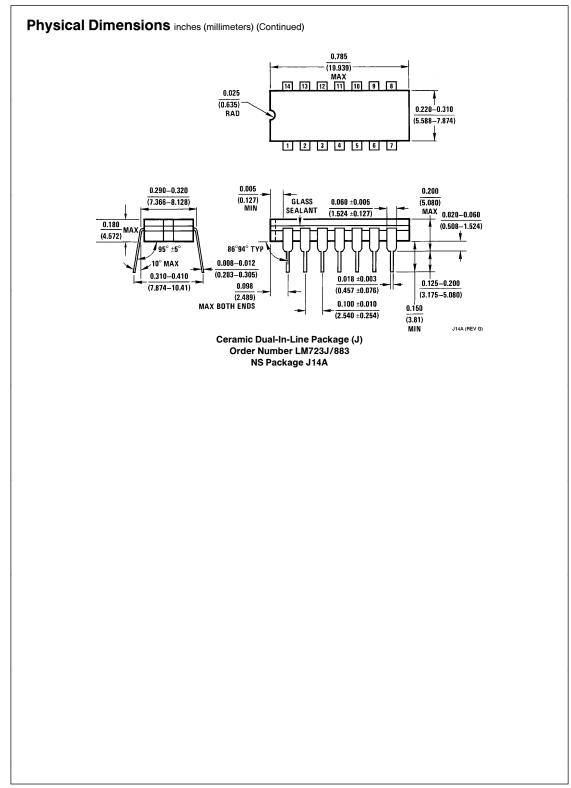


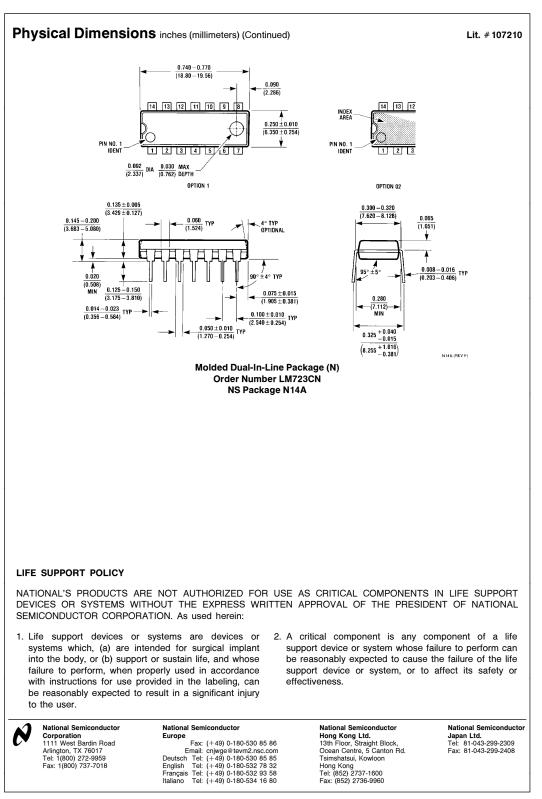












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